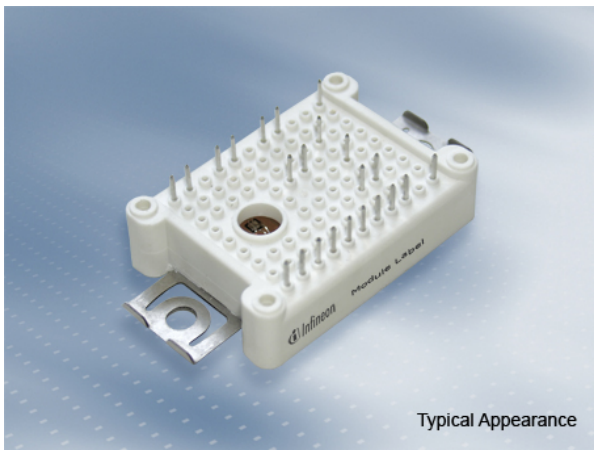
技术信息 / Technical Information

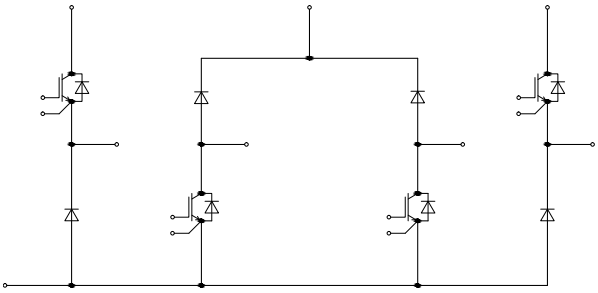
IGBT-模块
IGBT-Module

FD-DF80R12W1H3_B52

EasyPACK 模块 带有pressfit压接管脚和温度检测NTC
EasyPACK module and PressFIT / NTC

初步数据 / Preliminary Data





V_{CES} = 1200V
$I_{C\ nom}$ = 40A / I_{CRM} = 80A

典型应用
- 高频开关应用
- 太阳能应用

Typical Applications
- High Frequency Switching Application
- Solar Applications

电气特性
- 增加阻断电压至650V
- 高速IGBT H3
- 低电感设计
- 低 V_{CEsat}

Electrical Features
- Increased blocking voltage capability to 650V
- High Speed IGBT H3
- Low Inductive Design
- Low V_{CEsat}

机械特性
- 2.5 kV 交流 1分钟 绝缘
- PressFIT 压接技术
- 符合RoHS
- 集成的安装夹使安装坚固

Mechanical Features
- 2.5 kV AC 1min Insulation
- PressFIT Contact Technology
- RoHS compliant
- Rugged mounting due to integrated mounting clamps

Module Label Code

Barcode Code 128

Sample
00000123456000000000000

DMX - Code

Content of the Code	Digit
Module Serial Number	1 - 5
Module Material Number	6 - 11
Production Order Number	12 - 19
Datecode (Production Year)	20 - 21
Datecode (Production Week)	22 - 23

prepared by: CM	date of publication: 2014-07-21	
approved by: MB	revision: 2.0	UL approved (E83335)

初步数据
Preliminary Data

IGBT, 降壓轉換器的 / IGBT, Buck

最大额定值 / Maximum Rated Values

集电极 - 发射极电压 Collector-emitter voltage	T_{vj} = 25°C	V_{CES}	1200		V
连续集电极直流电流 Continuous DC collector current	T_C = 80°C, $T_{vj\,max}$ = 175°C	$I_{C\,nom}$	40		A
集电极重复峰值电流 Repetitive peak collector current	t_P = 1 ms	I_{CRM}	80		A
总功率损耗 Total power dissipation	T_C = 25°C, $T_{vj\,max}$ = 175°C	P_{tot}	215		W
栅极 - 发射极峰值电压 Gate-emitter peak voltage		V_{GES}	+/-20		V

特征值 / Characteristic Values

			min.	typ.	max.	
集电极 - 发射极饱和电压 Collector-emitter saturation voltage	I_C = 40 A, V_{GE} = 15 V I_C = 40 A, V_{GE} = 15 V I_C = 40 A, V_{GE} = 15 V	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	$V_{CE\,sat}$		2,05 2,50 2,60	2,40	V V V
栅极阈值电压 Gate threshold voltage	I_C = 1,00 mA, V_{CE} = V_{GE}, T_{vj} = 25°C		V_{GEth}	5,0	5,8	6,5	V
栅极电荷 Gate charge	V_{GE} = -15 V ... +15 V		Q_G		0,185		µC
内部栅极电阻 Internal gate resistor	T_{vj} = 25°C		R_{Gint}		0,0		Ω
输入电容 Input capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V		C_{ies}		2,35		nF
反向传输电容 Reverse transfer capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V		C_{res}		0,13		nF
集电极-发射极截止电流 Collector-emitter cut-off current	V_{CE} = 1200 V, V_{GE} = 0 V, T_{vj} = 25°C		I_{CES}			1,0	mA
栅极-发射极漏电流 Gate-emitter leakage current	V_{CE} = 0 V, V_{GE} = 20 V, T_{vj} = 25°C		I_{GES}			100	nA
开通延迟时间(电感负载) Turn-on delay time, inductive load	I_C = 40 A, V_{CE} = 600 V V_{GE} = ±15 V R_{Gon} = 12 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	$t_{d\,on}$		0,02 0,02 0,023		µs µs µs
上升时间(电感负载) Rise time, inductive load	I_C = 40 A, V_{CE} = 600 V V_{GE} = ±15 V R_{Gon} = 12 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	t_r		0,02 0,02 0,02		µs µs µs
关断延迟时间(电感负载) Turn-off delay time, inductive load	I_C = 40 A, V_{CE} = 600 V V_{GE} = ±15 V R_{Goff} = 12 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	$t_{d\,off}$		0,22 0,26 0,28		µs µs µs
下降时间(电感负载) Fall time, inductive load	I_C = 40 A, V_{CE} = 600 V V_{GE} = ±15 V R_{Goff} = 12 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	t_f		0,025 0,035 0,04		µs µs µs
开通损耗能量 (每脉冲) Turn-on energy loss per pulse	I_C = 40 A, V_{CE} = 600 V, L_S = 25 nH V_{GE} = ±15 V, di/dt = 1900 A/µs (T_{vj} = 150°C) R_{Gon} = 12 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	E_{on}		2,50 3,70 4,00		mJ mJ mJ
关断损耗能量 (每脉冲) Turn-off energy loss per pulse	I_C = 40 A, V_{CE} = 600 V, L_S = 25 nH V_{GE} = ±15 V, du/dt = 4700 V/µs (T_{vj} = 150°C) R_{Goff} = 12 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	E_{off}		1,50 2,35 2,50		mJ mJ mJ
短路数据 SC data	V_{GE} ≤ 15 V, V_{CC} = 800 V V_{CEmax} = V_{CES} -L_{sCE} ·di/dt	t_P ≤ 10 µs, T_{vj} = 150°C	I_{SC}		130		A
结 - 外壳热阻 Thermal resistance, junction to case	每个 IGBT / per IGBT		R_{thJC}		0,55	0,70	K/W
外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个 IGBT / per IGBT λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)		R_{thCH}		0,55		K/W
在开关状态下温度 Temperature under switching conditions			$T_{vj\,op}$	-40		150	°C

prepared by: CM	date of publication: 2014-07-21
approved by: MB	revision: 2.0

初步数据
Preliminary Data

反向二极管 / Diode, Reverse

最大额定值 / Maximum Rated Values

反向重复峰值电压 Repetitive peak reverse voltage	T_{vj} = 25°C	V_{RRM}	1200		V
连续正向直流电流 Continuous DC forward current		I_F	10		A
正向重复峰值电流 Repetitive peak forward current	t_P = 1 ms	I_{FRM}	20		A
I2t-值 I²t - value	V_R = 0 V, t_P = 10 ms, T_{vj} = 125°C V_R = 0 V, t_P = 10 ms, T_{vj} = 150°C	I²t	16,0 14,0		A²s A²s

特征值 / Characteristic Values

			min.	typ.	max.	
正向电压 Forward voltage	I_F = 10 A, V_{GE} = 0 V, T_{vj} = 25°C I_F = 10 A, V_{GE} = 0 V, T_{vj} = 125°C I_F = 10 A, V_{GE} = 0 V, T_{vj} = 150°C	V_F		1,75 1,75 1,75	2,25	V V V
结 - 外壳热阻 Thermal resistance, junction to case	每个二极管 / per diode	R_{thJC}		1,75	1,90	K/W
外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个二极管 / per diode λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		1,30		K/W
在开关状态下温度 Temperature under switching conditions		$T_{vj\,op}$	-40		150	°C

Diode, 降壓轉換器的 / Diode, Buck

最大额定值 / Maximum Rated Values

反向重复峰值电压 Repetitive peak reverse voltage	T_{vj} = 25°C	V_{RRM}	1200		V
连续正向直流电流 Continuous DC forward current		I_F	15		A
正向重复峰值电流 Repetitive peak forward current	t_P = 1 ms	I_{FRM}	30		A
I2t-值 I²t - value	V_R = 0 V, t_P = 10 ms, T_{vj} = 125°C V_R = 0 V, t_P = 10 ms, T_{vj} = 150°C	I²t	90,0 75,0		A²s A²s

特征值 / Characteristic Values

			min.	typ.	max.	
正向电压 Forward voltage	I_F = 15 A, V_{GE} = 0 V, T_{vj} = 25°C I_F = 15 A, V_{GE} = 0 V, T_{vj} = 125°C I_F = 15 A, V_{GE} = 0 V, T_{vj} = 150°C	V_F		2,00 1,70 1,65	2,55	V V V
反向恢复峰值电流 Peak reverse recovery current	I_F = 15 A, - di_F/dt = 1500 A/µs (T_{vj}=150°C), T_{vj} = 25°C V_R = 600 V, T_{vj} = 125°C V_{GE} = -15 V, T_{vj} = 150°C	I_{RM}		30,0 40,0 40,0		A A A
恢复电荷 Recovered charge	I_F = 15 A, - di_F/dt = 1500 A/µs (T_{vj}=150°C), T_{vj} = 25°C V_R = 600 V, T_{vj} = 125°C V_{GE} = -15 V, T_{vj} = 150°C	Q_r		0,70 2,50 3,00		µC µC µC
反向恢复损耗（每脉冲） Reverse recovery energy	I_F = 15 A, - di_F/dt = 1500 A/µs (T_{vj}=150°C), T_{vj} = 25°C V_R = 600 V, T_{vj} = 125°C V_{GE} = -15 V, T_{vj} = 150°C	E_{rec}		0,40 0,85 1,10		mJ mJ mJ
结 - 外壳热阻 Thermal resistance, junction to case	每个二极管 / per diode	R_{thJC}		0,95	1,05	K/W
外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个二极管 / per diode λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		0,85		K/W
在开关状态下温度 Temperature under switching conditions		$T_{vj\,op}$	-40		150	°C

初步数据
Preliminary Data

IGBT, 轉換器 / IGBT, Boost

最大额定值 / Maximum Rated Values

集电极 - 发射极电压 Collector-emitter voltage	T_{vj} = 25°C	V_{CES}	650		V
集电极电流 Implemented collector current		I_{CN}	50		A
连续集电极直流电流 Continuous DC collector current	T_C = 100°C, $T_{vj\,max}$ = 175°C	$I_{C\,nom}$	40		A
集电极重复峰值电流 Repetitive peak collector current	t_P = 1 ms	I_{CRM}	100		A
总功率损耗 Total power dissipation	T_C = 25°C, $T_{vj\,max}$ = 175°C	P_{tot}	200		W
栅极 - 发射极峰值电压 Gate-emitter peak voltage		V_{GES}	+/-20		V

特征值 / Characteristic Values

			min.	typ.	max.	
集电极 - 发射极饱和电压 Collector-emitter saturation voltage	I_C = 40 A, V_{GE} = 15 V I_C = 40 A, V_{GE} = 15 V I_C = 40 A, V_{GE} = 15 V	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	$V_{CE\,sat}$		1,55 1,70 1,70	t.b.d.	V V V
栅极阈值电压 Gate threshold voltage	I_C = 0,80 mA, V_{CE} = V_{GE}, T_{vj} = 25°C		V_{GEth}	4,9	5,8	6,5	V
栅极电荷 Gate charge	V_{GE} = -15 V ... +15 V		Q_G		0,50		µC
内部栅极电阻 Internal gate resistor	T_{vj} = 25°C		R_{Gint}		0,0		Ω
输入电容 Input capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V		C_{ies}		2,95		nF
反向传输电容 Reverse transfer capacitance	f = 1 MHz, T_{vj} = 25°C, V_{CE} = 25 V, V_{GE} = 0 V		C_{res}		0,096		nF
集电极-发射极截止电流 Collector-emitter cut-off current	V_{CE} = 650 V, V_{GE} = 0 V, T_{vj} = 25°C		I_{CES}			1,0	mA
栅极-发射极漏电流 Gate-emitter leakage current	V_{CE} = 0 V, V_{GE} = 20 V, T_{vj} = 25°C		I_{GES}			100	nA
开通延迟时间(电感负载) Turn-on delay time, inductive load	I_C = 40 A, V_{CE} = 350 V V_{GE} = ±15 V R_{Gon} = 6,8 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	$t_{d\,on}$		0,02 0,02 0,02		µs µs µs
上升时间(电感负载) Rise time, inductive load	I_C = 40 A, V_{CE} = 350 V V_{GE} = ±15 V R_{Gon} = 6,8 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	t_r		0,01 0,013 0,013		µs µs µs
关断延迟时间(电感负载) Turn-off delay time, inductive load	I_C = 40 A, V_{CE} = 350 V V_{GE} = ±15 V R_{Goff} = 6,8 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	$t_{d\,off}$		0,03 0,065 0,07		µs µs µs
下降时间(电感负载) Fall time, inductive load	I_C = 40 A, V_{CE} = 350 V V_{GE} = ±15 V R_{Goff} = 6,8 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	t_f		0,012 0,013 0,014		µs µs µs
开通损耗能量 (每脉冲) Turn-on energy loss per pulse	I_C = 40 A, V_{CE} = 350 V, L_S = 25 nH V_{GE} = ±15 V, di/dt = 3200 A/µs (T_{vj} = 150°C) R_{Gon} = 6,8 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	E_{on}		0,33 0,47 0,50		mJ mJ mJ
关断损耗能量 (每脉冲) Turn-off energy loss per pulse	I_C = 40 A, V_{CE} = 350 V, L_S = 25 nH V_{GE} = ±15 V, du/dt = 5000 V/µs (T_{vj} = 150°C) R_{Goff} = 6,8 Ω	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	E_{off}		0,60 0,85 0,95		mJ mJ mJ
短路数据 SC data	V_{GE} ≤ 15 V, V_{CC} = 360 V V_{CEmax} = V_{CES} -L_{sCE} ·di/dt	t_P ≤ 5 µs, T_{vj} = 150°C	I_{SC}		180		A
结 - 外壳热阻 Thermal resistance, junction to case	每个 IGBT / per IGBT		R_{thJC}		0,60	0,75	K/W

初步数据
Preliminary Data

外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个 IGBT / per IGBT λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		0,85		K/W
在开关状态下温度 Temperature under switching conditions		$T_{vj\,op}$	-40		150	°C

Diode-斩波器 / Diode-Chopper

最大额定值 / Maximum Rated Values

反向重复峰值电压 Repetitive peak reverse voltage	T_{vj} = 25°C	V_{RRM}		650		V
连续正向直流电流 Continuous DC forward current		I_F		15		A
正向重复峰值电流 Repetitive peak forward current	t_P = 1 ms	I_{FRM}		30		A
I2t-值 I²t - value	V_R = 0 V, t_P = 10 ms, T_{vj} = 125°C V_R = 0 V, t_P = 10 ms, T_{vj} = 150°C	I²t		22,5 20,5		A²s A²s

特征值 / Characteristic Values

			min.	typ.	max.	
正向电压 Forward voltage	I_F = 15 A, V_{GE} = 0 V T_{vj} = 25°C I_F = 15 A, V_{GE} = 0 V T_{vj} = 125°C I_F = 15 A, V_{GE} = 0 V T_{vj} = 150°C	V_F		1,60 1,55 1,50	2,00	V V V
结 - 外壳热阻 Thermal resistance, junction to case	每个二极管 / per diode	R_{thJC}		2,25	2,50	K/W
外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个二极管 / per diode λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)	R_{thCH}		1,40		K/W
在开关状态下温度 Temperature under switching conditions		$T_{vj\,op}$	-40		150	°C

初步数据
Preliminary Data

Diode, 轉換器 / Diode, Boost

最大额定值 / Maximum Rated Values

反向重复峰值电压 Repetitive peak reverse voltage	T_{vj} = 25°C	V_{RRM}	650	V
连续正向直流电流 Continuous DC forward current		I_F	25	A
正向重复峰值电流 Repetitive peak forward current	t_P = 1 ms	I_{FRM}	50	A
I2t-值 I²t - value	V_R = 0 V, t_P = 10 ms, T_{vj} = 125°C	I²t	50,0	A²s

特征值 / Characteristic Values

			min.	typ.	max.	
正向电压 Forward voltage	I_F = 25 A, V_{GE} = 0 V I_F = 25 A, V_{GE} = 0 V I_F = 25 A, V_{GE} = 0 V	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	V_F		1,65 1,60 1,55	t.b.d.	V V V
反向恢复峰值电流 Peak reverse recovery current	I_F = 25 A, - di_F/dt = 2500 A/µs (T_{vj}=150°C) V_R = 350 V V_{GE} = -15 V	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	I_{RM}		38,0 43,0 45,0		A A A
恢复电荷 Recovered charge	I_F = 25 A, - di_F/dt = 2500 A/µs (T_{vj}=150°C) V_R = 350 V V_{GE} = -15 V	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	Q_r		0,90 1,60 1,90		µC µC µC
反向恢复损耗（每脉冲） Reverse recovery energy	I_F = 25 A, - di_F/dt = 2500 A/µs (T_{vj}=150°C) V_R = 350 V V_{GE} = -15 V	T_{vj} = 25°C T_{vj} = 125°C T_{vj} = 150°C	E_{rec}		0,24 0,38 0,44		mJ mJ mJ
结 - 外壳热阻 Thermal resistance, junction to case	每个二极管 / per diode		R_{thJC}		1,95	2,15	K/W
外壳 - 散热器热阻 Thermal resistance, case to heatsink	每个二极管 / per diode λ_{Paste} = 1 W/(m·K) / λ_{grease} = 1 W/(m·K)		R_{thCH}		1,35		K/W
在开关状态下温度 Temperature under switching conditions			$T_{vj\,op}$	-40		150	°C

负温度系数热敏电阻 / NTC-Thermistor

特征值 / Characteristic Values

			min.	typ.	max.	
额定电阻值 Rated resistance	T_C = 25°C	R_{25}		5,00		kΩ
R100 偏差 Deviation of R100	T_C = 100°C, R_{100} = 493 Ω	ΔR/R	-5		5	%
耗散功率 Power dissipation	T_C = 25°C	P_{25}			20,0	mW
B-值 B-value	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15\ K))]$	$B_{25/50}$		3375		K
B-值 B-value	$R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15\ K))]$	$B_{25/80}$		3411		K
B-值 B-value	$R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15\ K))]$	$B_{25/100}$		3433		K

根据应用手册标定
Specification according to the valid application note.

初步数据
Preliminary Data

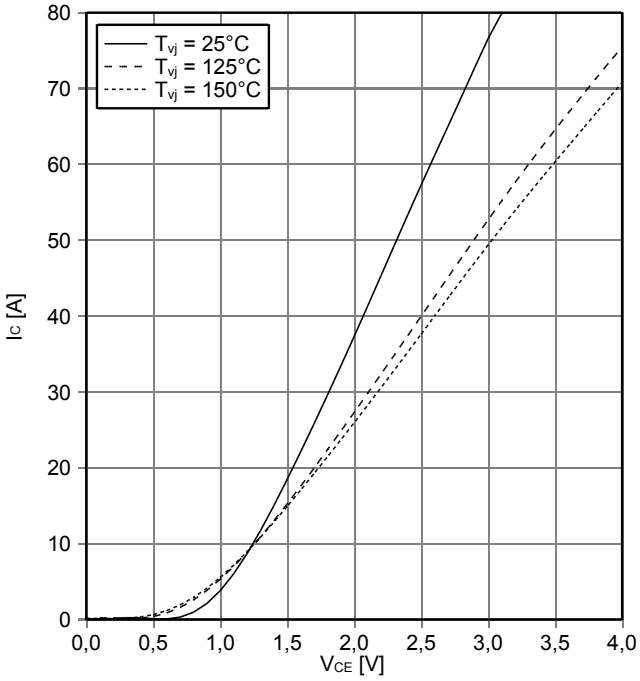
模块 / Module

绝缘测试电压 Isolation test voltage	RMS, f = 50 Hz, t = 1 min.	V_{ISOL}		2,5		kV
内部绝缘 Internal isolation	基本绝缘 (class 1, IEC 61140) basic insulation (class 1, IEC 61140)			Al_2O_3		
爬电距离 Creepage distance	端子至散热器 / terminal to heatsink 端子至端子 / terminal to terminal			11,5 6,3		mm
电气间隙 Clearance	端子至散热器 / terminal to heatsink 端子至端子 / terminal to terminal			10,0 5,0		mm
相对电痕指数 Comperative tracking index		CTI		> 200		
			min.	typ.	max.	
杂散电感,模块 Stray inductance module		L_{sCE}		25		nH
储存温度 Storage temperature		T_{stg}	-40		125	°C
Anpresskraft für mech. Bef. pro Feder mountig force per clamp		F	20	-	50	N
重量 Weight		G		24		g

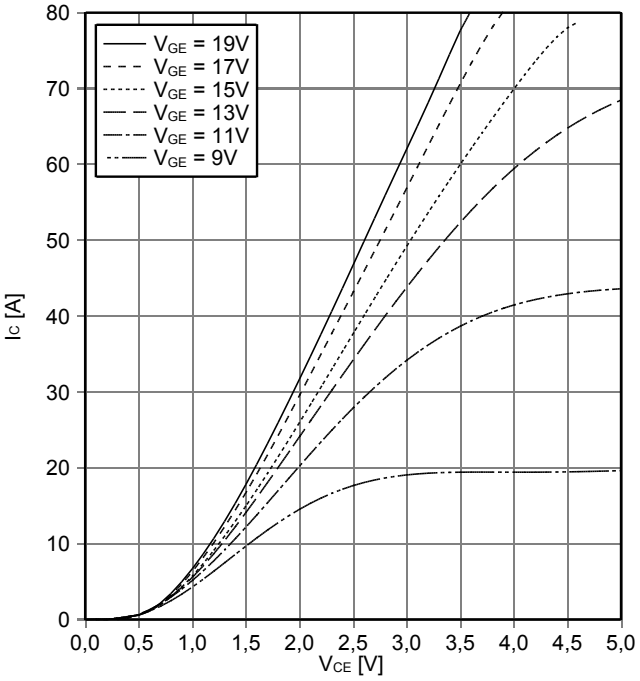
Der Strom im Dauerbetrieb ist auf 25 A effektiv pro Anschlusspin begrenzt.
The current under continuous operation is limited to 25 A rms per connector pin.

初步数据
Preliminary Data

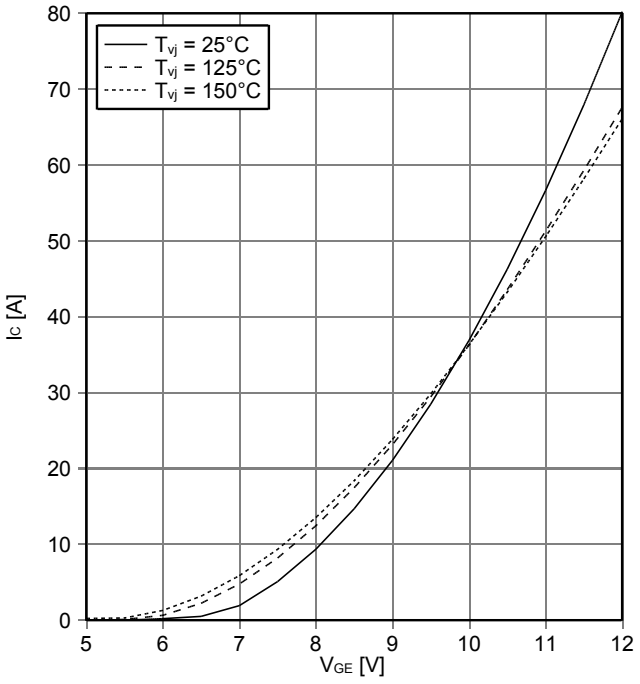
输出特性 IGBT, 降壓轉換器的 (典型)
output characteristic IGBT, Buck (typical)
$I_C = f(V_{CE})$
V_{GE} = 15 V



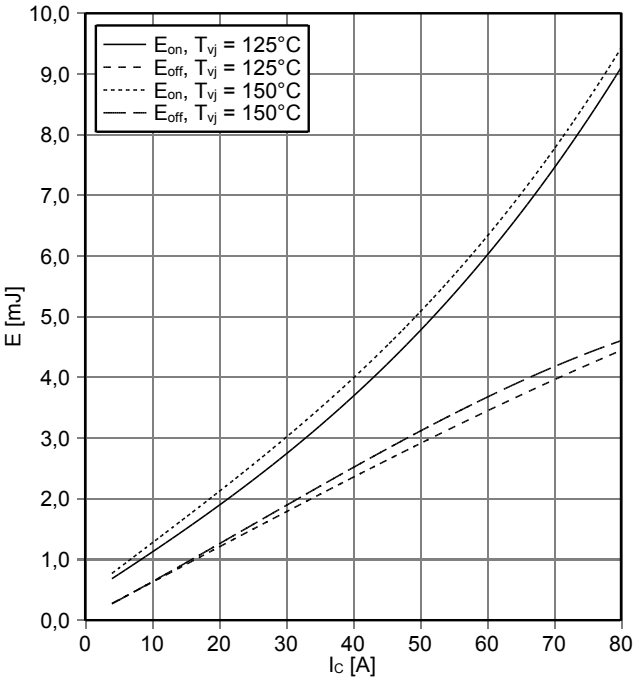
输出特性 IGBT, 降壓轉換器的 (典型)
output characteristic IGBT, Buck (typical)
$I_C = f(V_{CE})$
T_{vj} = 150°C



传输特性 IGBT, 降壓轉換器的 (典型)
transfer characteristic IGBT, Buck (typical)
$I_C = f(V_{GE})$
V_{CE} = 20 V



开关损耗 IGBT, 降壓轉換器的 (典型)
switching losses IGBT, Buck (typical)
$E_{on} = f(I_C)$, $E_{off} = f(I_C)$
V_{GE} = ±15 V, R_{Gon} = 12 Ω, R_{Goff} = 12 Ω, V_{CE} = 600 V



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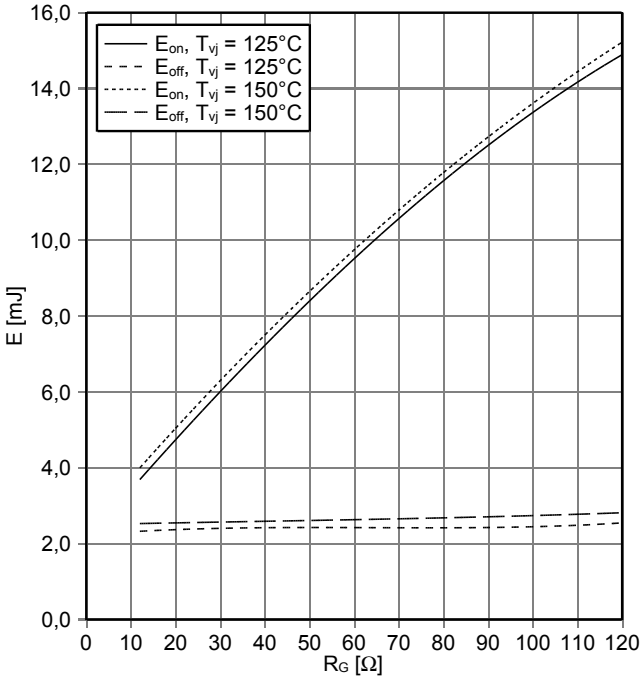
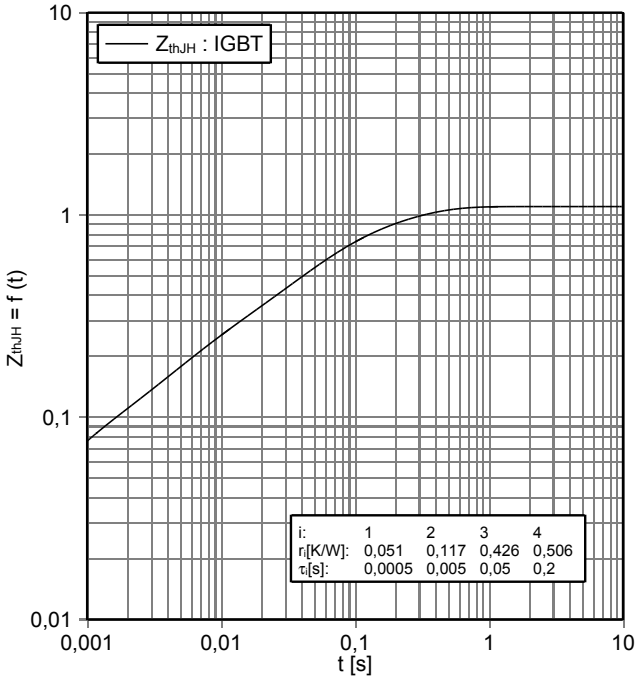
初步数据
Preliminary Data

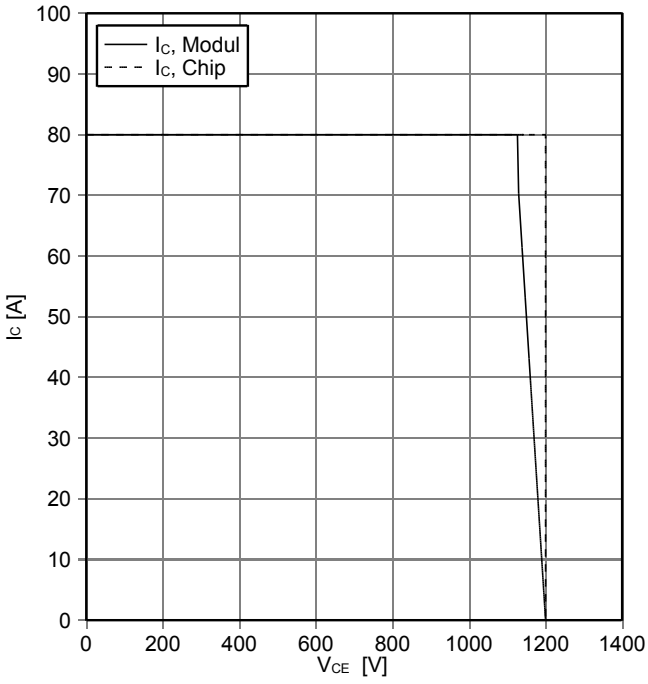
开关损耗 IGBT, 降壓轉換器的 （典型)
switching losses IGBT, Buck (typical)
$E_{on} = f(R_G)$, $E_{off} = f(R_G)$
V_{GE} = ±15 V, I_C = 40 A, V_{CE} = 600 V



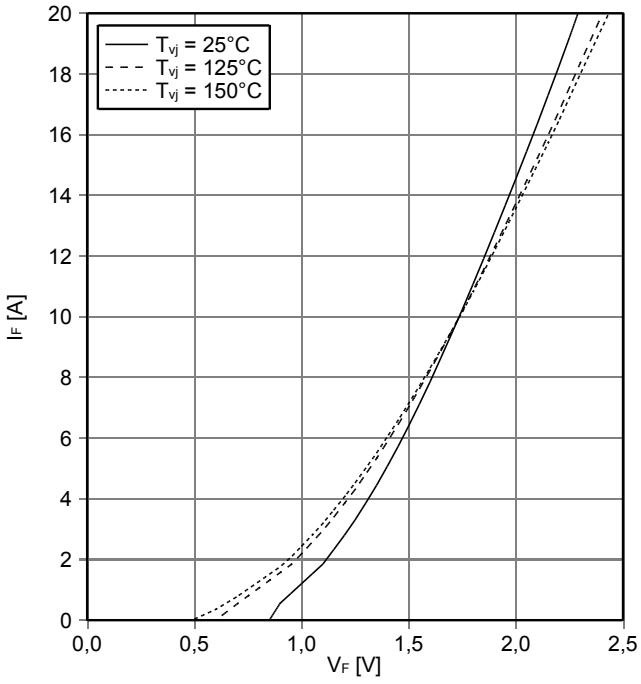
瞬态热阻抗 IGBT, 降壓轉換器的
transient thermal impedance IGBT, Buck
$Z_{thJH} = f(t)$



反偏安全工作区 IGBT, 降壓轉換器的 （RBSOA）
reverse bias safe operating area IGBT, Buck (RBSOA)
$I_C = f(V_{CE})$
V_{GE} = ±15 V, R_{Goff} = 12 Ω, T_{vj} = 150°C



正向偏压特性 反向二极管 （典型)
forward characteristic of Diode, Reverse (typical)
$I_F = f(V_F)$



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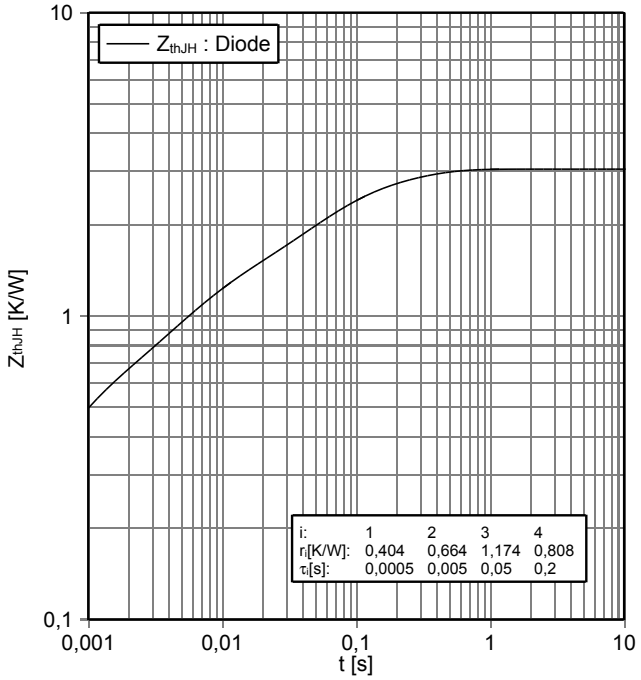
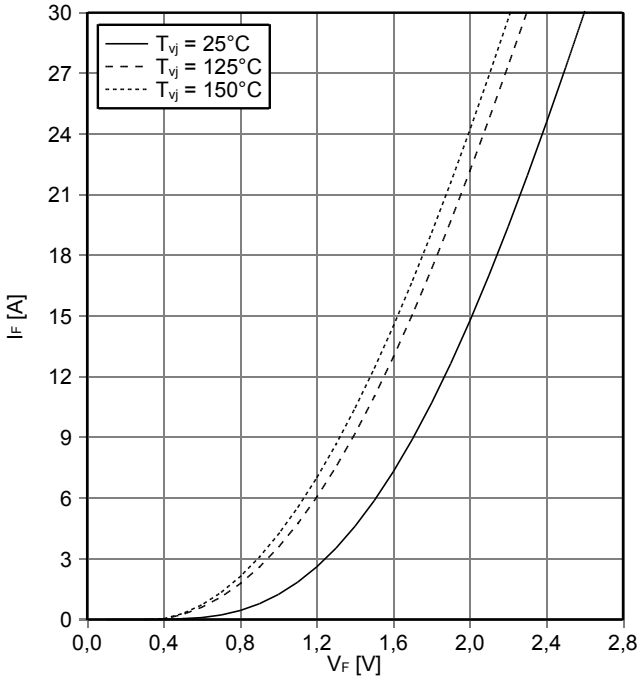
初步数据
Preliminary Data

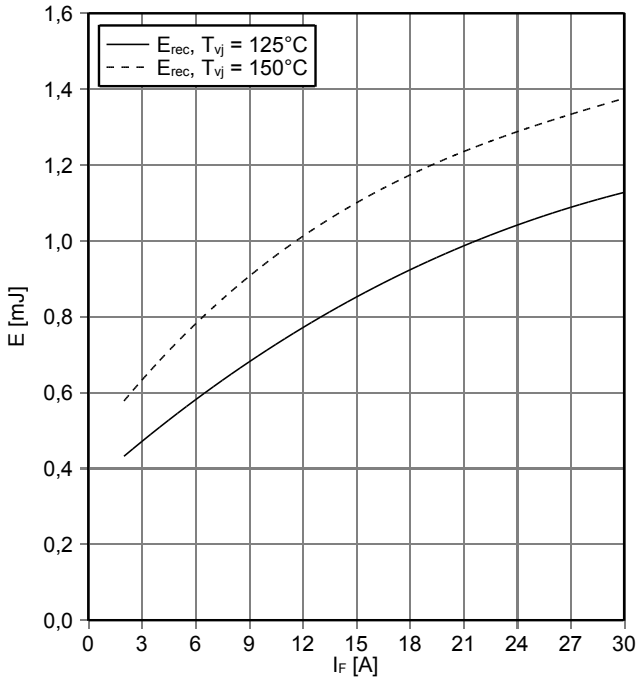
瞬态热阻抗 反向二极管
transient thermal impedance Diode, Reverse
$Z_{thJH} = f(t)$



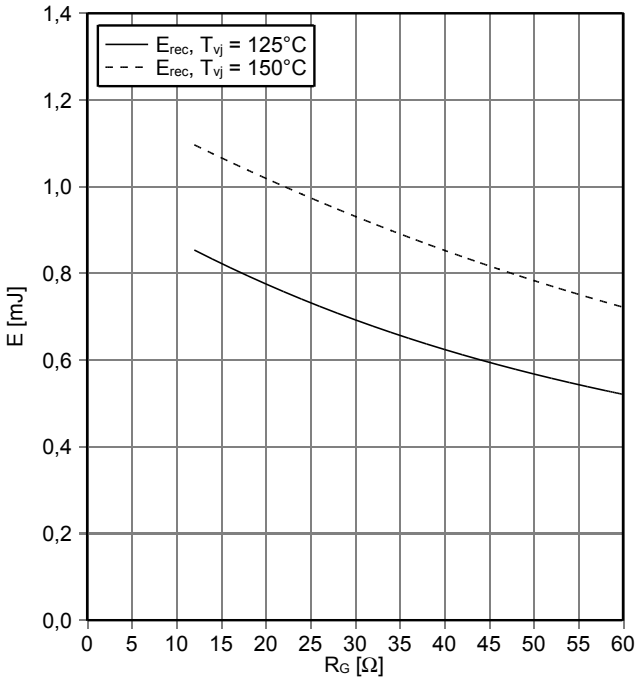
正向偏压特性 Diode, 降壓轉換器的 (典型)
forward characteristic of Diode, Buck (typical)
$I_F = f(V_F)$



开关损耗 Diode, 降壓轉換器的 (典型)
switching losses Diode, Buck (typical)
$E_{rec} = f(I_F)$
$R_{Gon} = 12\ \Omega$, $V_{CE} = 600$ V



开关损耗 Diode, 降壓轉換器的 (典型)
switching losses Diode, Buck (typical)
$E_{rec} = f(R_G)$
$I_F = 15$ A, $V_{CE} = 600$ V



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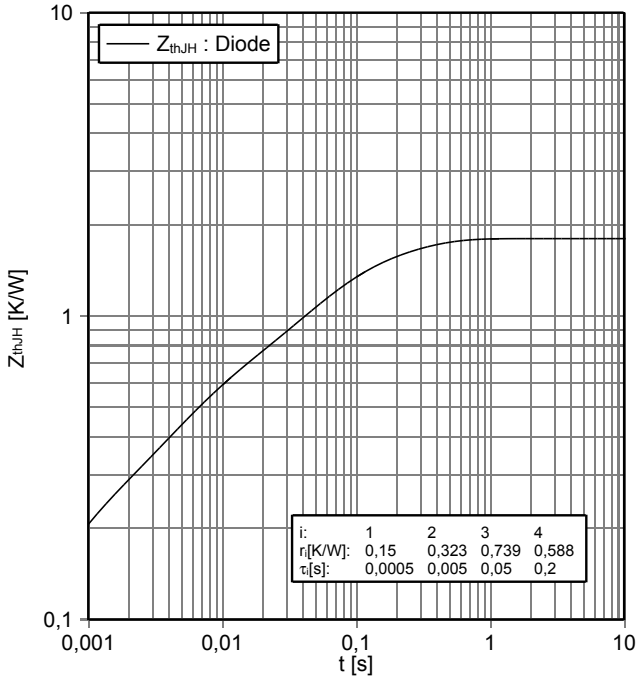
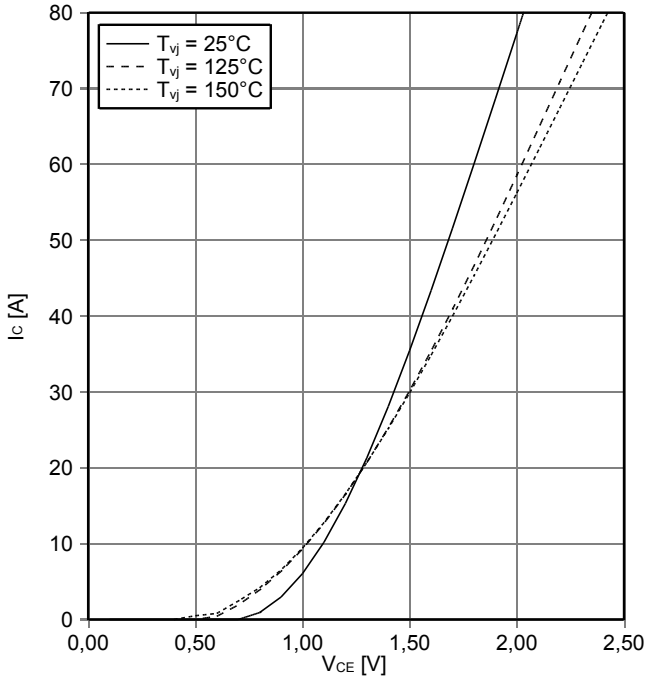
初步数据
Preliminary Data

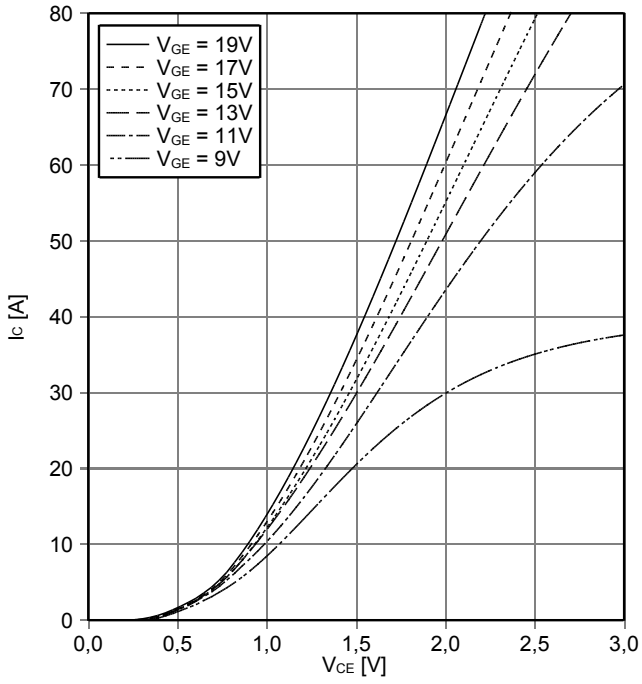
瞬态热阻抗 Diode, 降壓轉換器的
transient thermal impedance Diode, Buck
$Z_{thJH} = f(t)$



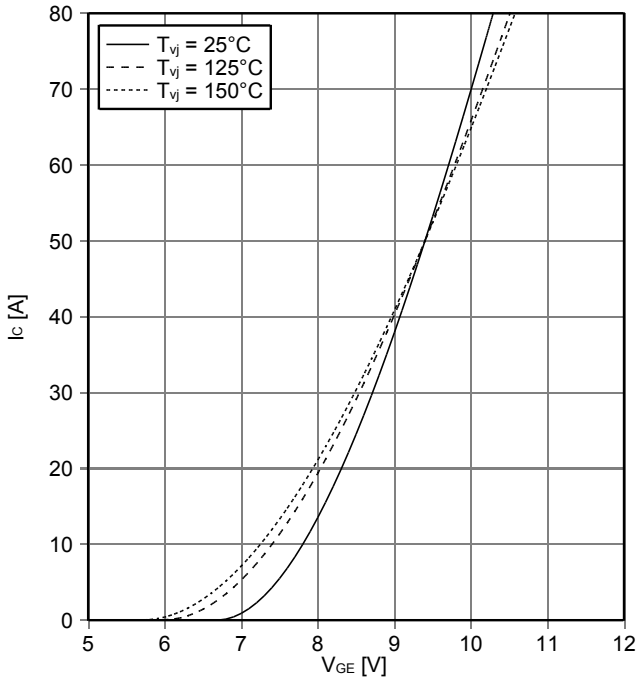
输出特性 IGBT, 轉換器 （典型）
output characteristic IGBT, Boost (typical)
$I_C = f(V_{CE})$
$V_{GE} = 15\ V$



输出特性 IGBT, 轉換器 （典型）
output characteristic IGBT, Boost (typical)
$I_C = f(V_{CE})$
$T_{vj} = 150°C$



传输特性 IGBT, 轉換器 (典型)
transfer characteristic IGBT, Boost (typical)
$I_C = f(V_{GE})$
$V_{CE} = 20\ V$



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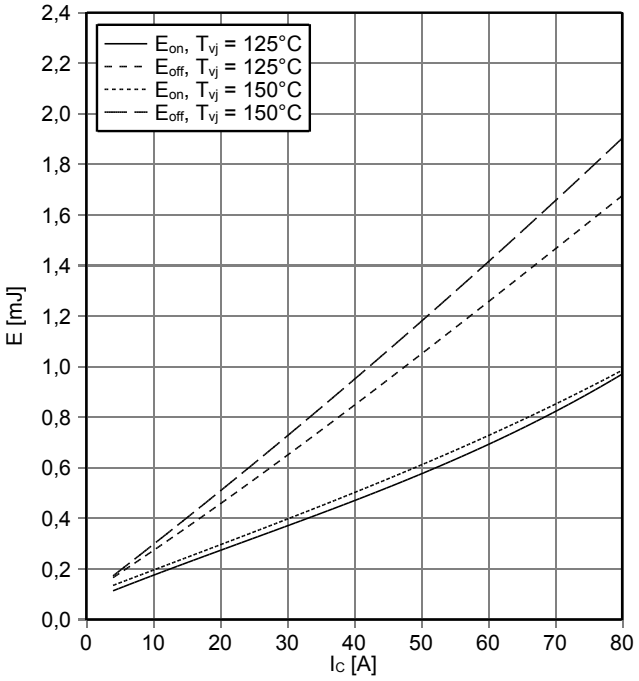
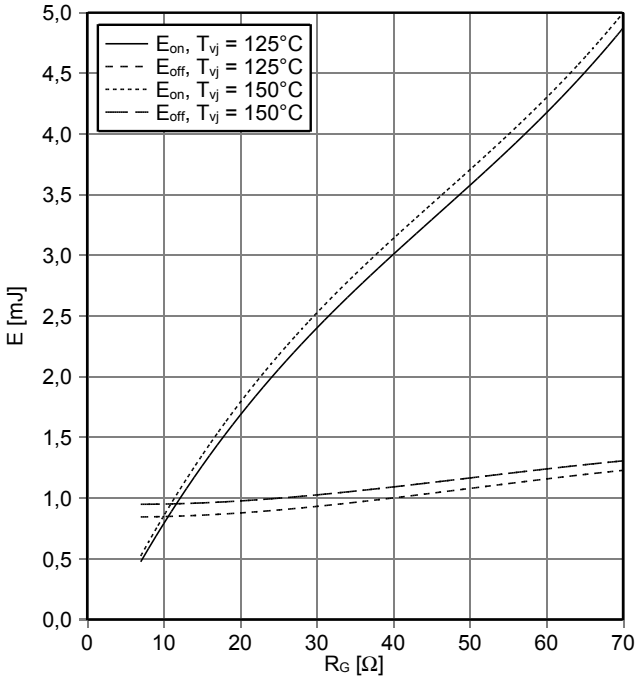
初步数据
Preliminary Data

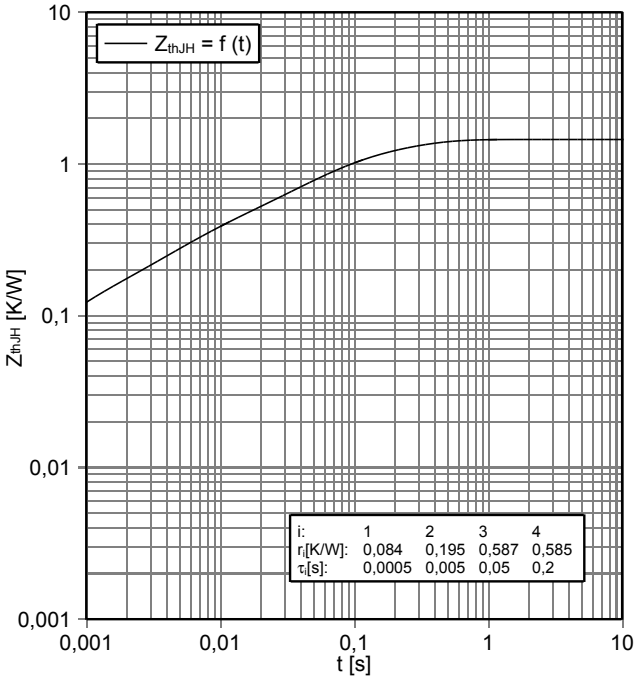
开关损耗 IGBT, 轉換器 （典型）
switching losses IGBT, Boost (typical)
$E_{on} = f(I_C)$, $E_{off} = f(I_C)$
V_{GE} = ±15 V, R_{Gon} = 6.8 Ω, R_{Goff} = 6.8 Ω, V_{CE} = 350 V



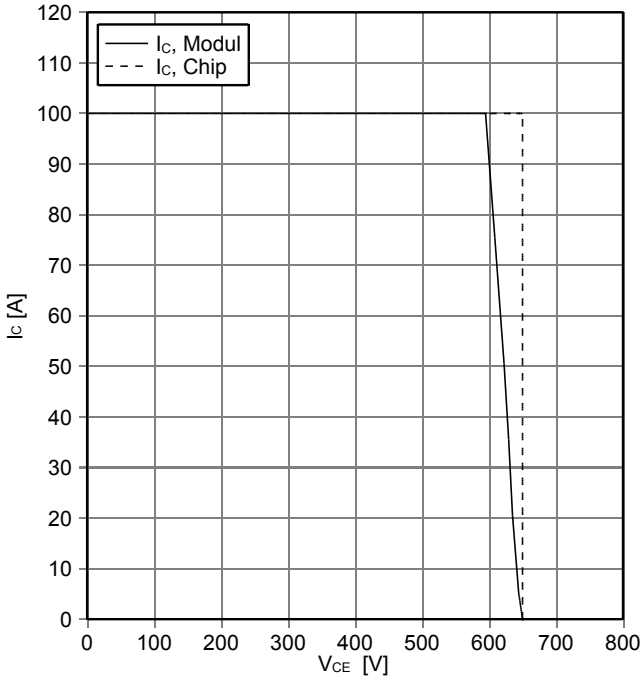
开关损耗 IGBT, 轉換器 （典型）
switching losses IGBT, Boost (typical)
$E_{on} = f(R_G)$, $E_{off} = f(R_G)$
V_{GE} = ±15 V, I_C = 40 A, V_{CE} = 350 V



瞬态热阻抗 IGBT, 轉換器
transient thermal impedance IGBT, Boost
$Z_{thJH} = f(t)$



反偏安全工作区 IGBT, 轉換器 （RBSOA）
reverse bias safe operating area IGBT, Boost (RBSOA)
$I_C = f(V_{CE})$
V_{GE} = ±15 V, R_{Goff} = 6.8 Ω, T_{vj} = 150°C



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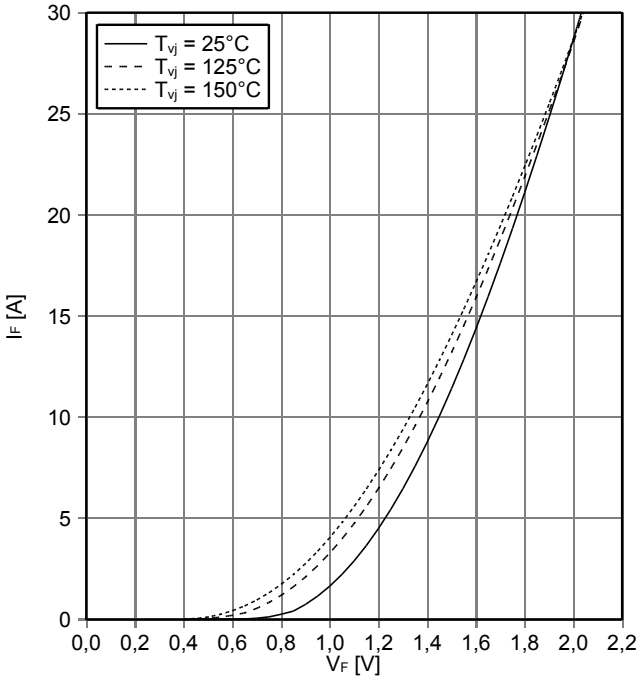
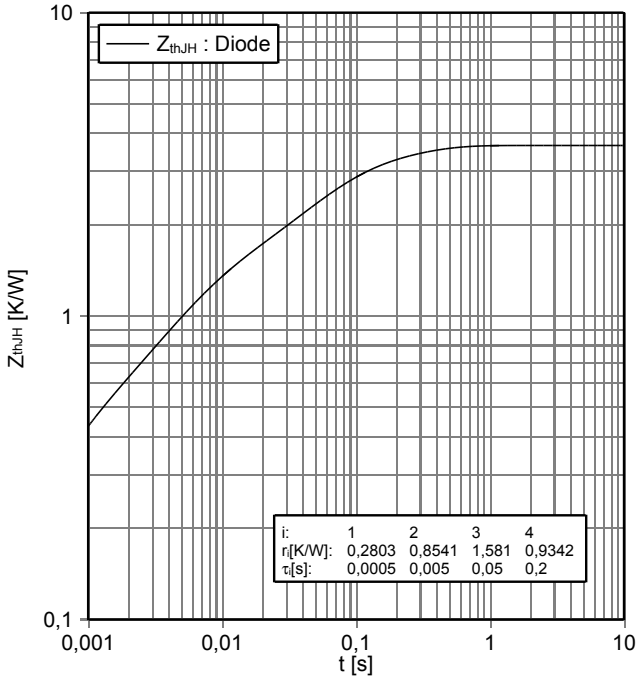
初步数据
Preliminary Data

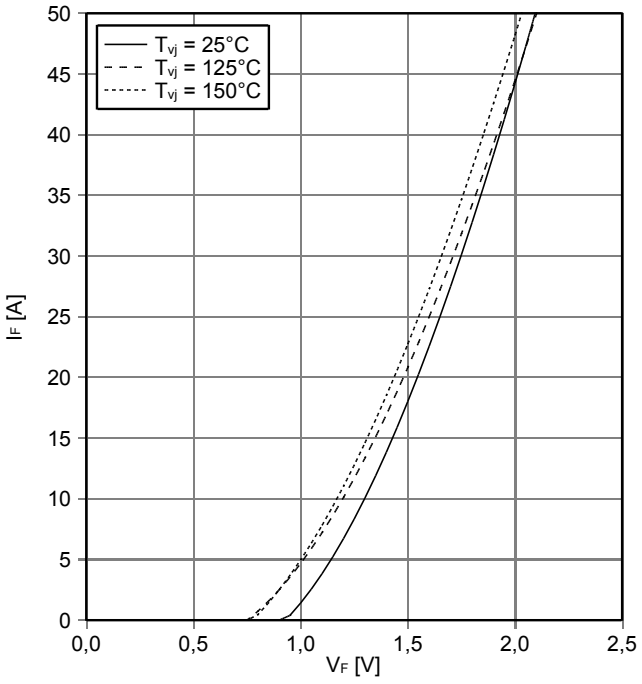
正向偏压特性 Diode-斩波器 （典型）
forward characteristic of Diode-Chopper (typical)
$I_F = f(V_F)$



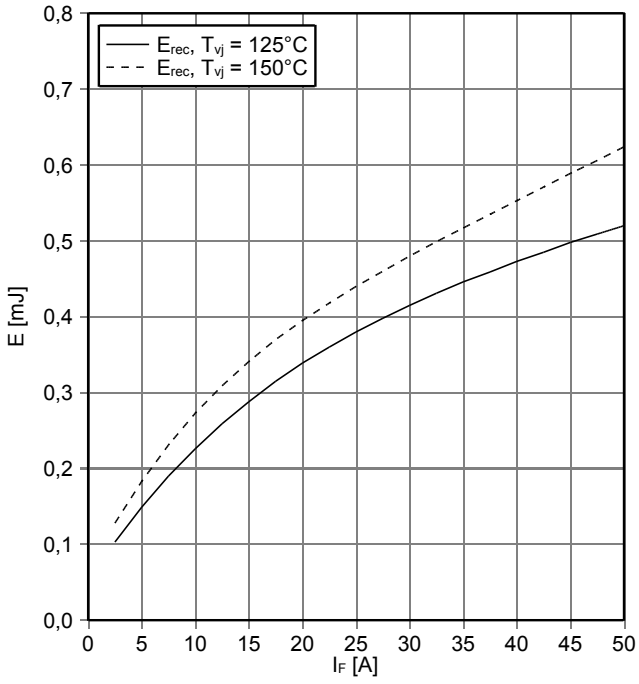
瞬态热阻抗 Diode-斩波器
transient thermal impedance Diode-Chopper
$Z_{thJH} = f(t)$



正向偏压特性 Diode, 轉換器 （典型）
forward characteristic of Diode, Boost (typical)
$I_F = f(V_F)$



开关损耗 Diode, 轉換器 （典型）
switching losses Diode, Boost (typical)
$E_{rec} = f(I_F)$
$R_{Gon} = 6.8\ \Omega$, $V_{CE} = 350\ V$



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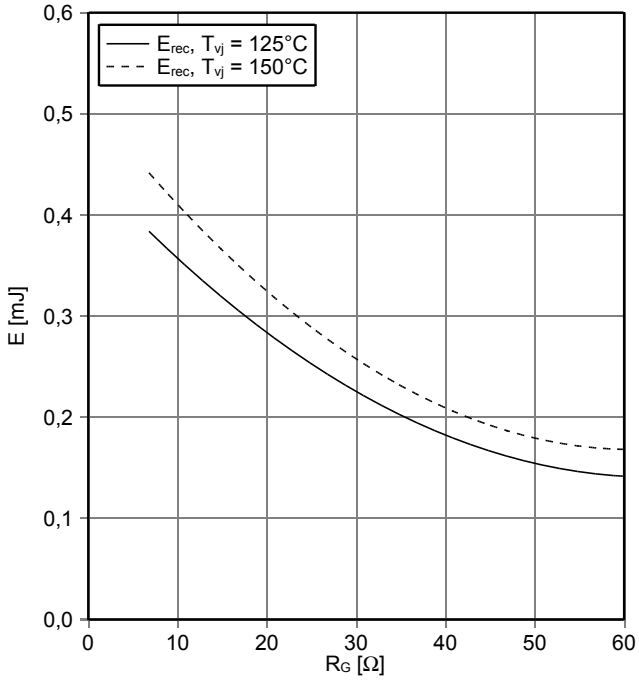
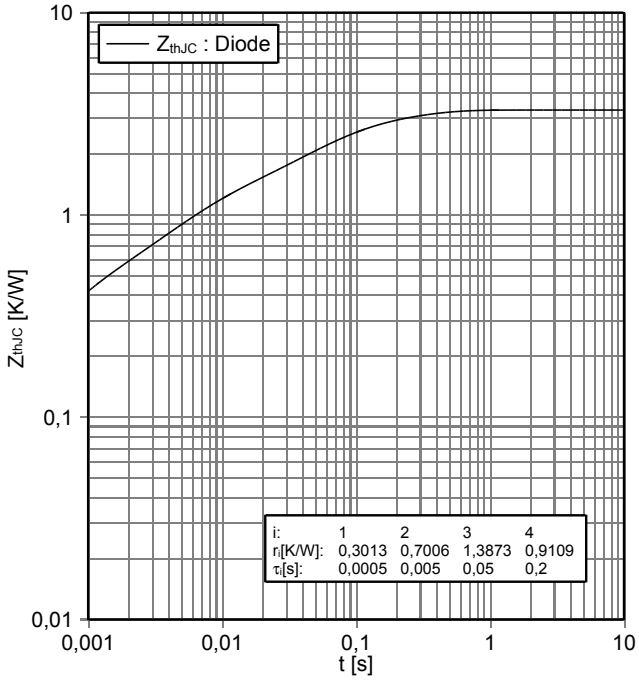
初步数据
Preliminary Data

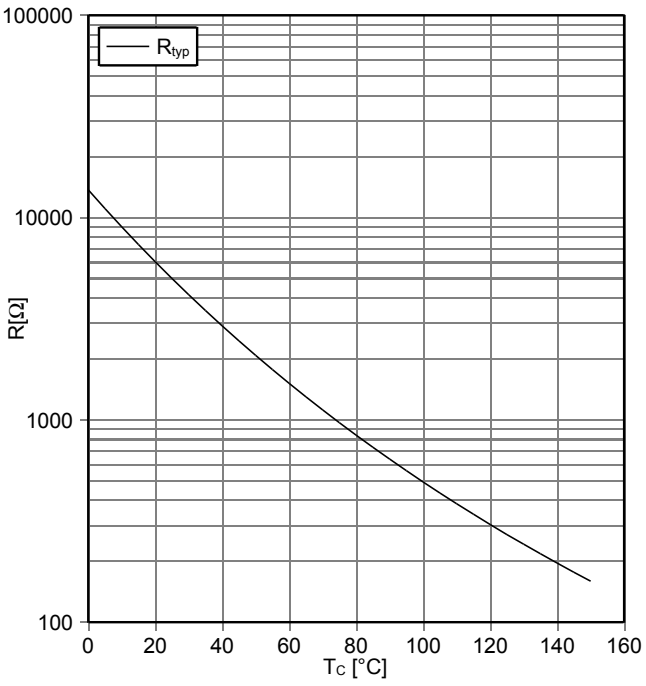
开关损耗 Diode, 轉換器 (典型)
switching losses Diode, Boost (typical)
$E_{rec} = f(R_G)$
$I_F = 25\ A$, $V_{CE} = 350\ V$



瞬态热阻抗 Diode, 轉換器
transient thermal impedance Diode, Boost
$Z_{thJC} = f(t)$



负温度系数热敏电阻 温度特性
NTC-Thermistor-temperature characteristic (typical)
$R = f(T)$



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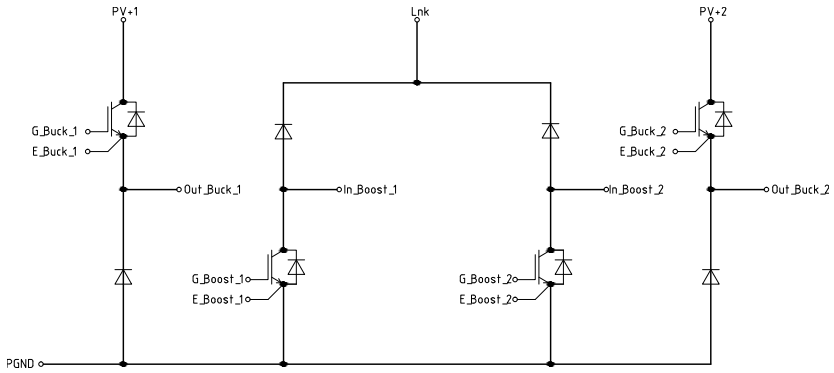
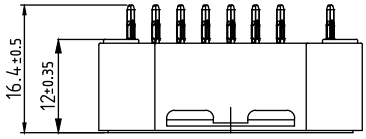
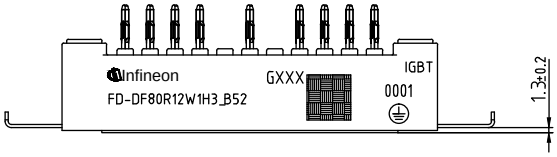
初步数据
Preliminary Data

接线图 / circuit_diagram_headline

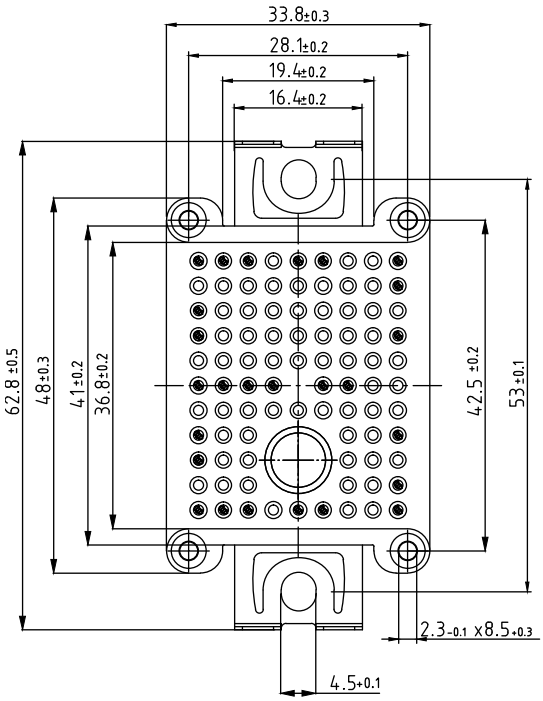


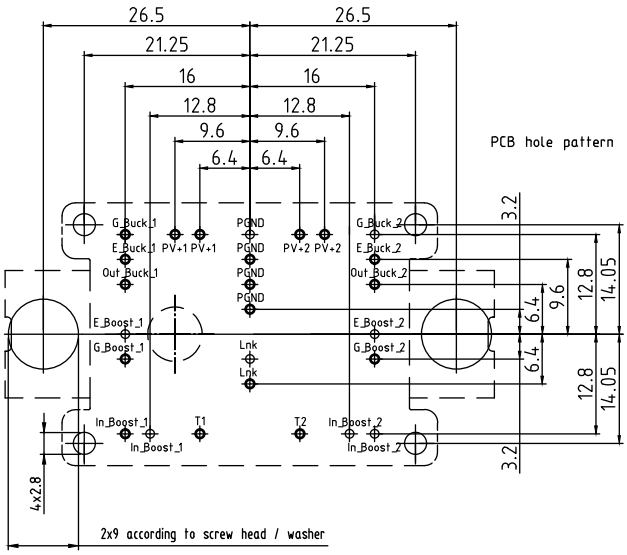
封装尺寸 / package outlines





- Pin-Grid 3.2mm
- Tolerance of PCB hole pattern ⌖ ø0.1
- Hole specification for contacts see AN 2009-01:
  Diameters of drill ø 1.15mm
  and copper thickness in hole 25-50µm





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初步数据
Preliminary Data

使用条件和条款

使用条件和条款
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由于技术需要，我们的产品可能含有危险物质。如果需要查询类似问题请联系我们负责你的销售部门
如果您想将我们的产品用于航天，健康，危及生命或者生命维持等应用，请申明。
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-执行联合的风险和质量评估
-得到质量协议的结论
- 建立联合的测试和出厂产品检查， 我们可以根据测试的实际情况供货
如果有必要，请根据实际需要将类似的说明给你的客户
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The data contained in this product data sheet is exclusively intended for technically trained staff. You and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application.

This product data sheet is describing the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its characteristics. The information in the valid application- and assembly notes of the module must be considered.

Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of our product, please contact the sales office, which is responsible for you (see www.infineon.com). For those that are specifically interested we may provide application notes.

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Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify. Please note, that for any such applications we urgently recommend
- to perform joint Risk and Quality Assessments;
- the conclusion of Quality Agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery depended on the realization of any such measures.

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